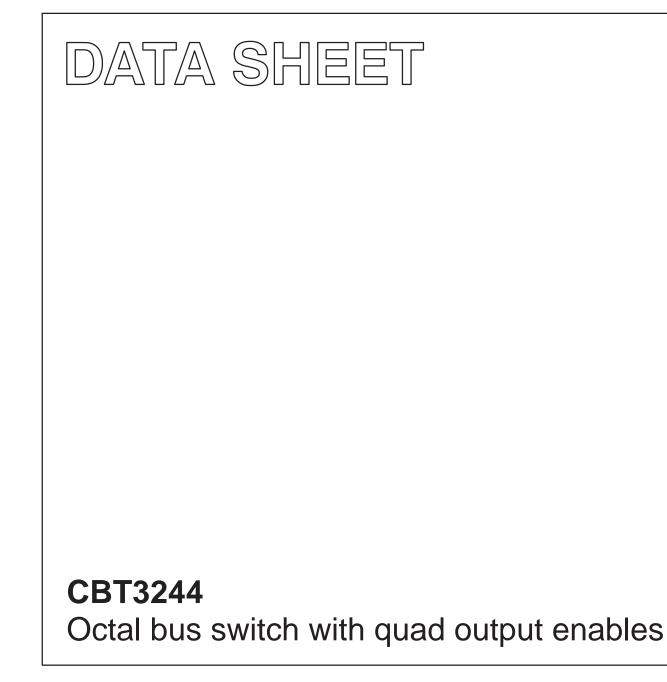
INTEGRATED CIRCUITS



Product specification Supersedes data of 1998 Dec 8 2000 Jun 19



CBT3244

FEATURES

- Standard '244-type pinout
- 5 Ω switch connection between two ports
- TTL compatible control input levels
- Package options include plastic small outline (D), shrink small outline (DB), thin shrink small outline (TSSOP)
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

DESCRIPTION

The CBT3244 provides eight bits of high-speed TTL-compatible bus switching in a standard '244 device pinout. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3244 device is organized as two 4-bit low-impedance switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the switch is on and data can flow from port A to port B, or vice versa. When \overline{OE} is high, the switch is open and high-impedance state exists between the two ports.

The CBT3244 is characterized for operation from -40°C to 85°C.

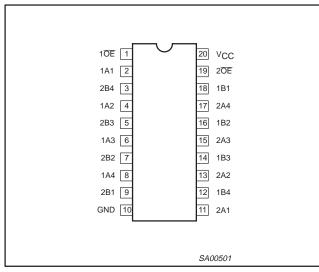
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	C _L = 50pF; V _{CC} = 5V		ns
C _{IO(OFF)}	Pin capacitance (OFF state)	$V_{O} = 3V \text{ or } 0V$	6	pF
I _{CCZ}	Total supply current	Outputs disabled; V_{CC} =5.5V		μΑ

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
20-Pin Plastic TSSOP Type I	-40°C to 85°C	CBT3244 PW DH	SOT360-1
20-Pin Plastic SSOP Type I	-40°C to 85°C	CBT3244 PW DB	SOT339-1
20-Pin Plastic SO Type I	-40°C to 85°C	CBT3244 PW D	SOT163-1

PIN CONFIGURATION

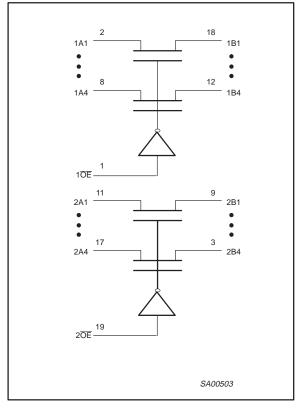


PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 19	10E, 20E	Output enable
2, 4, 6, 8	1A1–1A4	Inputs
11, 13, 15, 17	2A1–2A4	Inputs
18, 16, 14, 12	1B1–1B4	Outputs
9, 7, 5, 3	2B1–2B4	Outputs
10	GND	Ground (0V)
20	V _{CC}	Positive supply voltage

CBT3244

LOGIC SYMBOL



FUNCTION TABLE

INP	JTS	OUTPUTS		
1 <mark>0E</mark>	2 <mark>0E</mark>	1A, 1B	2A, 2B	
L	L	1A = 1B	2A = 2B	
L	Н	1A = 1B	Z	
н	L	Z	2A = 2B	
н	Н	Z	Z	

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +7	V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

CBT3244

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
	PARAMETER	Min	Max	UNIT
V _{CC}	DC supply voltage	4.5	5.5	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

				LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	T _{amb} = −40°C to +85°C			UNIT	
			Min	Typ ¹	Max		
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_I = -18mA$			-1.2	V	
lı	Input leakage current	V_{CC} = 5.5V; V_I = GND or 5.5V			±5	μΑ	
I _{CC}	Quiescent supply current ²	V_{CC} = 5.5V; I_{O} = 0, V_{I} = V_{CC} or GND			50	μΑ	
ΔI _{CC}	Additional supply current per input pin ²	V_{CC} = 5.5V, one input at 3.4V, other inputs at V_{CC} or GND			3.5	mA	
Cl	Control pins	$V_I = 3V \text{ or } 0, \overline{OE} = V_{CC}$		3		pF	
C _{IO(OFF)}	Power-off leakage current	$V_{O} = 3V \text{ or } 0$		6		pF	
		$V_{CC} = 4.5V; V_1 = 0V; I_1 = 64mA$		5	7		
r _{on} ³	On-resistance	$V_{CC} = 4.5V; V_1 = 0V; I_1 = 30mA$		5	7	Ω	
		$V_{CC} = 4.5V; V_1 = 0V; I_I = 15mA$		10	15		

NOTES:

1. All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$ 2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND

Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

AC CHARACTERISTICS

 $GND = 0V; t_{R}; C_{L} = 50pF$

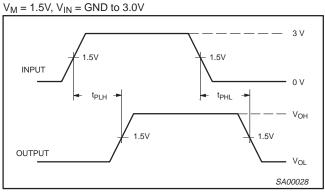
				74CBT3244 T _{amb} = -40°C to +85 V _{CC} = +5.0V ±0.5V		UNIT
SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)			
				Min	Max	
t _{pd}	Propagation delay ¹	A or B	B or A		.25	ns
t _{en}	Output enable time to High and Low level	OE	A or B	1.0	8.9	ns
t _{dis}	Output disable time from High and Low level	OE	A or B	1.0	7.4	ns

NOTE:

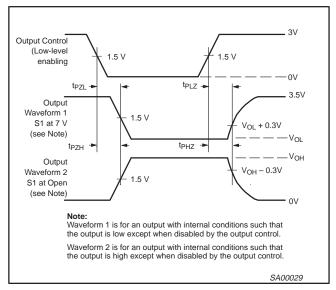
1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

CBT3244

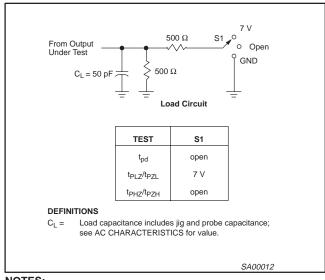
AC WAVEFORMS



Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times



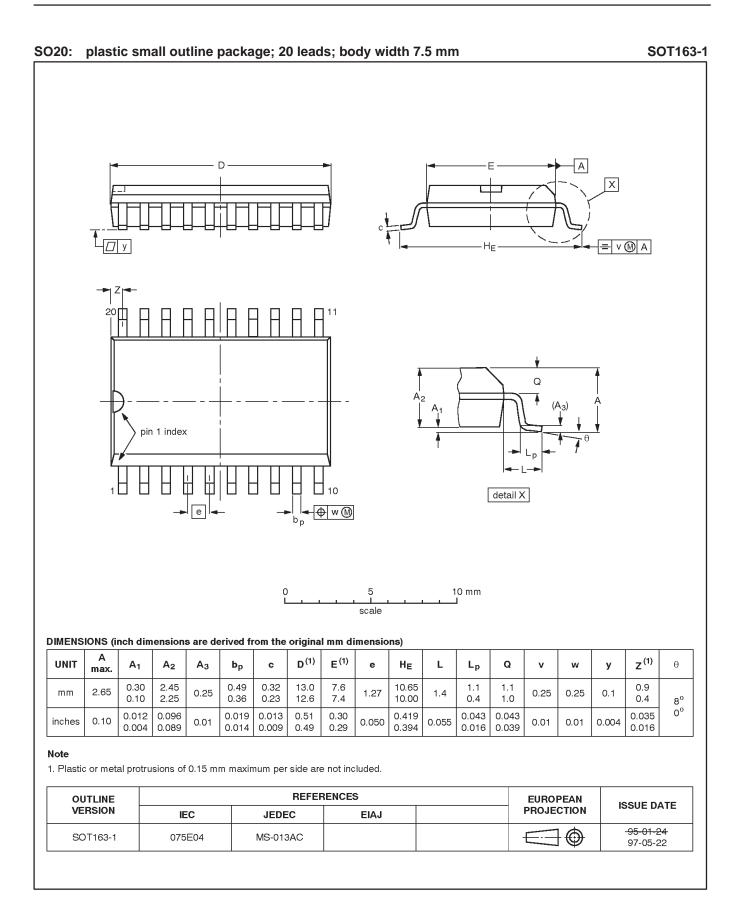
TEST CIRCUIT AND WAVEFORMS

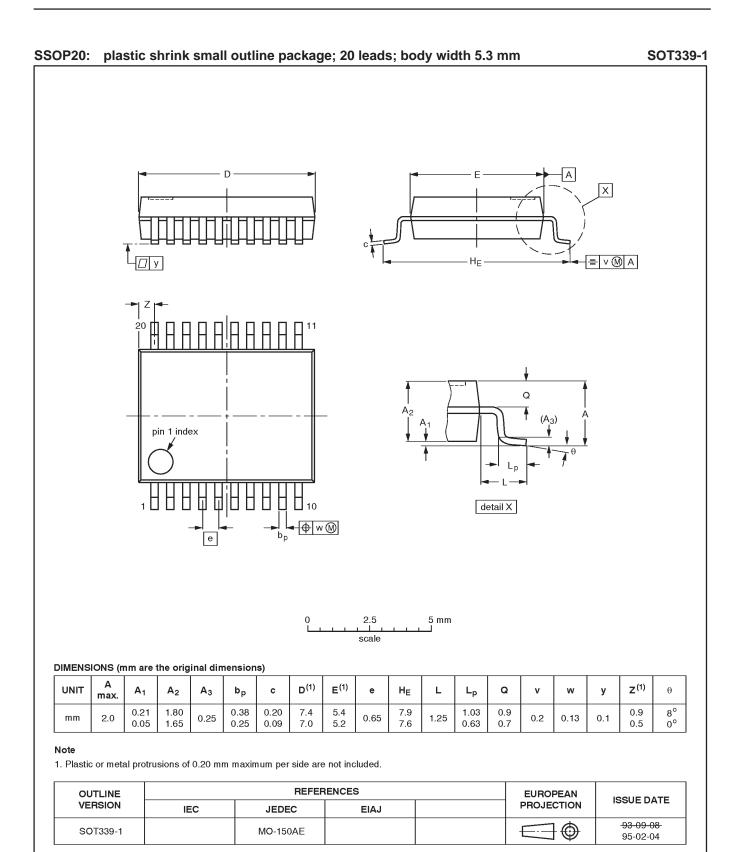
NOTES:

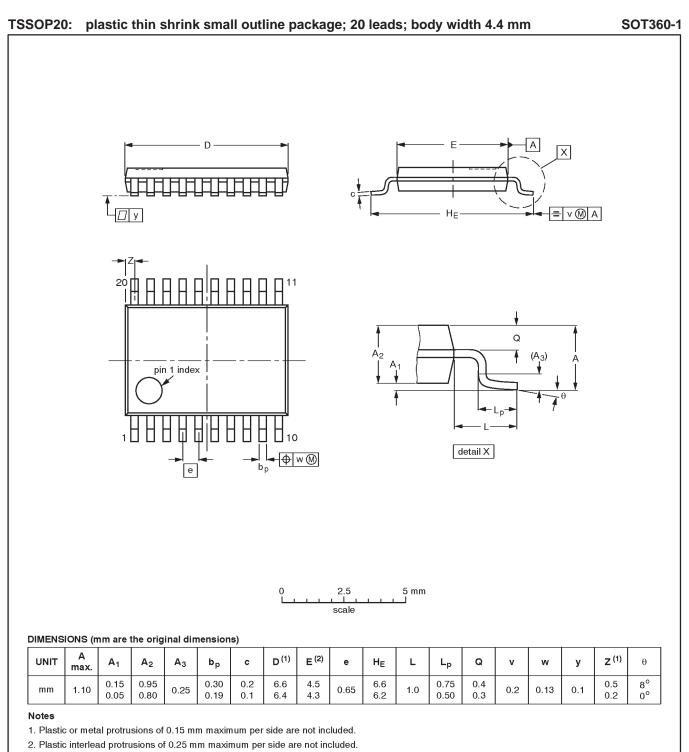
- 1. All input pulses are supplied by generators having the following characteristics: PRR \leq 10MHz, $Z_0 = 50 \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- 2. The outputs are measured one at a time with one transition per measurement.

Product specification

Octal bus switch with quad output enables







OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE
SOT360-1		MO-153AC				-93-06-16 95-02-04

Product specification

NOTES

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CBT3244

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition - Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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